LCD and Camera EMI Filter **Array with ESD Protection**

Description

The CM1451 is an inductor-capacitor (L-C) based EMI filter array with integrated ESD protection in CSP. The CM1451-06 and CM1451-08 are configured in 6 and 8 channel formats respectively. Each channel is implemented as a 5-pole L-C filter with the component values 9.5 pF - 17 nH - 9.5 pF - 17 nF - 9.5 pF. The CM1451's roll-off frequency at -10 dB attenuation is 500 MHz. It can be used in applications where the data rates are as high as 200 Mbps while providing greater than 35 dB attenuation over the 800 MHz to 2.7 GHz frequency range. The device has ESD protection diodes on every pin that provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD protection diodes connected to the filter ports safely dissipate ESD strikes of ±15 kV, exceeding the Level 4 requirement of the IEC61000-4-2 international standard. Using the MIL-STD-883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ± 30 kV.

This device is particularly well-suited for portable electronics (e.g. wireless handsets, PDAs) because of its small package format and easy-to-use pin assignments. In particular, the CM1451 is ideal for EMI filtering and protecting data and control lines for the LCD display and camera interface in wireless handsets while maintaining the integrity of signals that have rise/fall times as fast as 2 ns.

The CM1451 incorporates OptiGuard, a coating that results in improved reliability at assembly. The CM1451 is available in a space-saving, low-profile Chip Scale Package with RoHS compliant lead-free finishing.

Features

- High Bandwidth, High RF Rejection Filter Array
- Six and Eight Channels of EMI Filtering
- Utilizes Inductor-Based Design Technology for True L-C Filter Implementation
- OptiGuard Coating for Improved Reliability
- Chip Scale Package (CSP) Features Extremely Low Lead Inductance for Optimum Filter and ESD Performance
- 15 kV ESD Protection on Each Channel (IEC 61000–4–2 Level 4, Contact Discharge)
- 30 kV ESD Protection on Each Channel (HBM)
- Better than 40 dB of Attenuation at 1 GHz
- Maintains Signal Integrity for Signals that Have a Risetime and Falltime as Fast as 2 ns

Applications

- LCD and Camera Data Lines in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- Wireless Handsets / Cell Phones



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WLCSP15 **CP SUFFIX** CASE 567BT



CASE 567CL

MARKING DIAGRAM

	N516		N518
15-	CM1451-06 Bump CSP Packa	age 2	CM1451–08 0–Bump CSP Package
	N516 N518	= CM14 = CM14	51–06CP 51–08CP

ORDERING INFORMATION

Device	Package	Shipping [†]
CM1451-06CP	CSP-15 (Pb-Free)	3500/Tape & Reel
CM1451-08CP	CSP-20 (Pb-Free)	3500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

- 15-Bump, 3.006 mm x 1.376 mm Footprint Chip Scale Package (CM1451–06CP)
- 20-Bump, 4.006 mm x 1.376 mm Footprint Chip Scale Package (CM1451–08CP)
- These Devices are Pb-Free and are RoHS Compliant
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers
- Handheld PCs / PDAs
- LCD and Camera Modules

BLOCK DIAGRAM



*See Package/Pinout Diagrams for expanded pin information.

PACKAGE / PINOUT DIAGRAMS



Note: Lead-free devices are specified by using a "+" character for the top side orientation mark.

Table 1	. PIN	DESCRIP	TIONS
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CM1451-06	CM1451-08			CM1451-06	CM1451-08		
Pin(s)	Pin(s)	Name	Description	Pin(s)	Pin(s)	Name	Description
A1	A1	FILTER1	Filter Channel 1	C1	C1	FILTER1	Filter Channel 1
A2	A2	FILTER2	Filter Channel 2	C2	C2	FILTER2	Filter Channel 2
A3	A3	FILTER3	Filter Channel 3	C3	C3	FILTER3	Filter Channel 3
A4	A4	FILTER4	Filter Channel 4	C4	C4	FILTER4	Filter Channel 4
A5	A5	FILTER5	Filter Channel 5	C5	C5	FILTER5	Filter Channel 5
A6	A6	FILTER6	Filter Channel 6	C6	C6	FILTER6	Filter Channel 6
-	A7	FILTER7	Filter Channel 7	-	C7	FILTER7	Filter Channel 7
-	A8	FILTER8	Filter Channel 8	-	C8	FILTER8	Filter Channel 8
B1-B3	B1-B4	GND	Device Ground				

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
Current per Inductor	30	mA
DC Package Power Rating	500	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
L _{TOT}	Total Channel Inductance (L1 + L2)			34		nH
L ₁ , L ₂	Inductance			17		nH
R _{DC IN-OUT}	DC Channel Resistance			18		Ω
C _{TOT}	Total Channel Capacitance $(C_1 + C_2 + C_3)$	At 2.5 V DC, 1 MHz, 30 mV AC	22.8	28.5	34.2	pF
C ₁ , C ₂ , C ₃	Capacitance	At 2.5 V DC, 1 MHz, 30 mV AC	7.6	9.5	11.4	pF
f _C	Cut–off Frequency $Z_{SOURCE} = 50 \ \Omega$, $Z_{LOAD} = 50 \ \Omega$			260		MHz
f _{RO}	Roll–off Frequency at –10 dB Attenuation Z_{SOURCE} = 50 Ω , Z_{LOAD} = 50 Ω			500		MHz
V _{DIODE}	Diode Standoff Voltage	I _{DIODE} = 10 μA		6.0		V
I _{LEAK}	Diode Leakage Current	V_{DIODE} = +3.3 V		0.1	1.0	μΑ
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10 mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Note 2)	30 15			kV
R _{DYN}	Dynamic Resistance Positive Negative			2.30 0.90		Ω

1. $T_A = 25^{\circ}C$ unless otherwise specified.

2. ESD applied to input and output pins with respect to GND, one at a time.

PERFORMANCE INFORMATION









Figure 2. Insertion Loss vs. Frequency (A2-C2 to GND B1)

PERFORMANCE INFORMATION (Cont'd)



Typical Filter Performance (T_A = 25°C, DC Bias = 0 V, 50 Ω Environment)





Figure 4. Insertion Loss vs. Frequency (A4-C4 to GND B2)

PERFORMANCE INFORMATION (Cont'd)









Figure 6. Insertion Loss vs. Frequency (A6-C6 to GND B3)

PERFORMANCE INFORMATION (Cont'd)



Figure 7. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5 VDC and 25°C)

Transient Response Characteristics



Figure 8. Simulated Transient Response (input signal risetime and falltime = 2 ns, clocked at 25, 50 and 75 MHz, 15 Ω Source Resistance, 5 pF Load)

APPLICATION INFORMATION

Table 5. PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	Value
Pad Size on PCB	0.240 mm
Pad Shape	Round
Pad Definition	Non-Solder Mask defined pads
Solder Mask Opening	0.290 mm Round
Solder Stencil Thickness	0.125 – 0.150 mm
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300 mm Round
Solder Flux Ratio	50/50 by volume
Solder Paste Type	No Clean
Pad Protective Finish	OSP (Entek Cu Plus 106A)
Tolerance – Edge To Corner Ball	±50 μm
Solder Ball Side Coplanarity	±20 μm
Maximum Dwell Time Above Liquidous	60 seconds
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C









PACKAGE DIMENSIONS

WLCSP20, 4.01x1.38 CASE 567CL-01 **ISSUE O**



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. COPLANARITY APPLIES TO SPHERICAL <u>CROWNS OF SOLDER BALLS.</u>

-				
	MILLIMETERS			
DIM	MIN	MAX		
Α	0.56	0.72		
A1	0.21	0.27		
A2	0.42 REF			
b	0.29	0.35		
D	4.01 BSC			
Е	1.38 BSC 0.50 BSC 0.435 BSC			
eD				
еE				

PACKAGE DIMENSIONS

WLCSP15, 3.01x1.38 CASE 567BT-01 ISSUE O



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